

THERMOSENSITIVE IC FOR RELATIVE TEMPERATURE DETERMINATION

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Abstract

The functioning algorithm and the scheme of the transducer unit applied in thermosensitive IC with relative temperature reading are proposed in this paper. The principal algorithm of functioning is in the formation of current with linear dependence on absolute temperature by additional transduction of current into differential signal with value determined by relative temperature scale.

Keywords

Thermosensitivity, transducer, IC (integrated circuit), temperature determination

1. Introduction

Weighty achievement of modern microelectronics is expansion of functional possibilities of sensor devices the prior of which are single chip ICs. On the up-to-date stage of development mono crystal sensor, ICs are used for measuring of temperature, magnetic field, stresses, force, pressure, flow etc. Thermosensitive ICs such as STP35 (Texas Instruments), AD 590 (Analog Devices), LM 3911 (National Semiconductor) are wide spread [1,2]. However,

such ICs form the signal with value determined by absolute temperature. The measurement of relative temperature on the base of those thermosensitive ICs is not effective enough. The requirement of signal, which value is determined by relative temperature, is considerable especially in biomedical electronics, environmental monitoring, etc.

Results of elaboration of functioning algorithm and scheme of transducer of bipolar thermosensitive IC with relative temperature reading are presented in this paper.

2. The principle of thermosensitive IC function

The conceptual diagram and suggested detailed electric scheme of thermosensitive IC for determination of relative temperature is shown in Fig. 1.

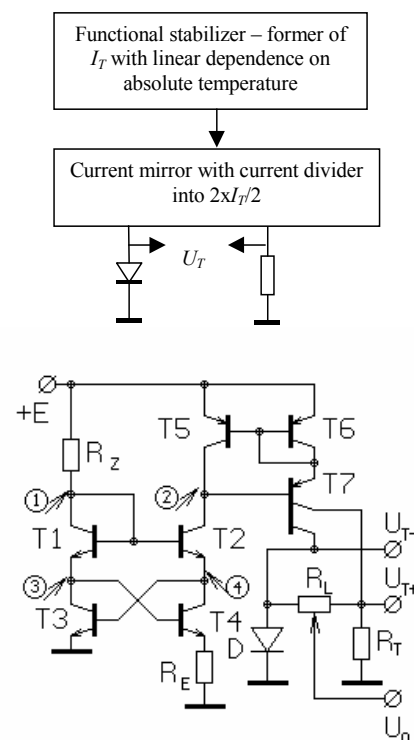


Fig. 1 Conceptual diagram and detailed electrical scheme of base variant of transducer with relative temperature reading

The main parts of the transducer are:

1. Functional stabilizer - former of I_T on the T_1 - T_4 , R_E , R_Z ,
2. "Current mirror" - divider on T_5 - T_7 ,
3. Formatting elements of relative temperature conductive scale D , R_T , R_L .

It can be proven at special conditions that the output differential voltage U_T depends only on relative temperature in arbitrary temperature scale. To prove this statement, the following analysis can be carried out.

Let us consider the generally known principle of current stabilizer functioning. According to its diagram in Figure 1, following system of basic equations can be fixed

$$\begin{cases} U_1 = U_{be2} + U_{be3} \\ U_1 = U_{be1} + U_{be4} + I(R_E) \cdot R_E \\ I_Z = I(R_Z) \approx I_{c1} \approx I_{c3} \\ I_T = I_{c2} \approx I_{c4} \approx I(R_E) \end{cases} \quad (1)$$

where U_{bei} are voltages on emitter p-n junctions of transistors (T_i) and I_{ci} are output (collector) currents of transistors (T_i).

Taking into account that the current-voltage characteristics (CVC) can be simplified for silicon p-n junctions at $U_{be} \gg \varphi_T$ voltages, i.e. at normal voltages of their direct bias.

$$\begin{aligned} I_i &= I_{0i} \left(\exp \frac{U_{bei}}{m\varphi_T} - 1 \right) \approx I_{0i} \exp \frac{U_{bei}}{m\varphi_T} \Rightarrow \\ U_{bei} &= m\varphi_T \ln \frac{I_i}{I_{0i}} \end{aligned} \quad (2)$$

where I_{0i} is the saturation current, $\varphi_T = k \cdot T / q$, m is factor of nonideality of p-n junction, k is Boltzmann constant, q is electron charge and T is absolute temperature.

From (1) and (2) equation (3) can be derived

$$\begin{aligned} I_T &= I(R_E) = \frac{U_{be2} + U_{be3} - U_{be1} - U_{be4}}{R_E} = \\ &= \frac{m\varphi_T}{R_E} \ln \frac{I_2 \cdot I_3 \cdot I_{01} \cdot I_{04}}{I_{02} \cdot I_{03} \cdot I_1 \cdot I_4} = \frac{m\varphi_T}{R_E} \ln \frac{I_{01} \cdot I_{04}}{I_{02} \cdot I_{03}} \end{aligned} \quad (3)$$

Considering that the active area of T_1 - T_3 transistors and the electro-physical parameters of their structure are mutually identical, $I_{01} = I_{02} = I_{03} = I_0$. Let the active area of T_4 emitter is p times larger than T_1 - T_3 emitter area, then $I_{04} = p \cdot I_0$. The equation (3) can be rewritten into the following form

$$I_T = \frac{m\varphi_T \ln p}{R_E} = \frac{mk \ln p}{rR_E} T \quad (4)$$

Current I_T is, in the first approximation, independent on the supply voltage and on the current through resistor R_Z , i.e. the non-stabilized supply voltage E can be used. The I_T value is characterized by linear dependence on the absolute temperature T . The transconductance of this dependence is

$$\frac{dI_T}{dT} = \frac{mk \ln p}{qR_E} \quad (5)$$

and the output voltages of transducer are

$$U_{T+} = \frac{R_T}{R_E} \cdot \frac{mk \cdot \ln p}{2q} \cdot T \quad (6)$$

$$U_{T-} = m\varphi_T \cdot \ln \frac{I_T}{2I_{0D}} \quad (7)$$

Let us determine the temperature factor of this voltage (TFV)

$$\frac{dU_{T+}}{dT} = \frac{R_T}{R_E} \frac{mk \cdot \ln p}{2}; \quad (8)$$

$$\frac{dU_{T-}}{dT} = \frac{d}{dT} \left(\frac{mkT}{q} \ln I_T - \frac{mkT}{q} \ln I_{0D} - \frac{mkT}{q} \ln 2 \right) \quad (9)$$

$$\begin{aligned} \frac{d}{dT} \left(\frac{mkT}{q} \ln I_T \right) &= \frac{mk}{q} \ln I_T + \frac{mkT}{q} \frac{1}{I_T} \frac{dI_T}{dT} = \\ &= \frac{mk}{q} (\ln I_T + 1); \end{aligned} \quad (10)$$

$$\frac{d}{dT} \left(\frac{mkT}{q} \ln I_{0D} \right) = \frac{mk}{q} \ln I_{0D} + \frac{mkT}{q} \frac{d(\ln I_{0D})}{dT}; \quad (11)$$

Let C is a constant, E_{G0} is the width of forbidden gap of silicon the value of which is $E_{G0} = 1,205V$ at absolute zero temperature. Then

$$\ln I_{0D} = \ln C + 3 \ln T - \frac{qE_{G0}}{kT}; \quad (12)$$

$$\frac{d(\ln I_{0D})}{dT} = \frac{3}{T} + \frac{qE_{G0}}{kT^2}; \quad (13)$$

$$\frac{d}{dT} \left(\frac{mkT}{q} \ln I_{0D} \right) = \frac{mk}{q} \left(\ln I_{0D} + 3 + \frac{qE_{G0}}{kT} \right); \quad (14)$$

$$\frac{d}{dT} \left(\frac{mkT}{q} \ln 2 \right) = \frac{mk}{q} \ln 2; \quad (15)$$

$$\frac{dU_{T-}}{dT} = \frac{mk}{q} \ln \frac{I_T}{2I_{0D}} - \frac{2kk}{q} - \frac{mE_{G0}}{T} \quad (16)$$

$$\frac{dU_{T-}}{dT} = - \left(mE_{G0} - \frac{mkT}{q} \ln \frac{I_T}{2I_{0D}} \right) / T - \frac{2mk}{q}; \quad (17)$$

$$\frac{dU_{T-}}{dT} = - \frac{mE_{G0} - U_T}{T} - \frac{2mk}{q} \quad (18)$$

The carried out analysis shows that:

1. the TFV of output voltage of U_{T+} is positive and can be given by relation between resistors of R_T/R_E ,
2. the TFV of U_T voltage is negative and is determined by difference between the width of forbidden gap of semiconductor and the voltage drop on p-n junction.

Let us consider, that, at the reference temperature T_0 of relative scale, the output voltages U_{T+} and U_{T-} are identical and equal to

$$U_{OR-} = U_{OR+} = \frac{R_T}{R_E} \cdot \frac{mk \cdot \ln p}{2q} \cdot T_0 \quad (19)$$

It allows to determine the relation R_T/R_E between resistors for such a condition

$$R_T = \frac{2U_{OR-}}{m\varphi_{T0} \ln p} R_E, \quad (20)$$

where $\varphi_{T0} = k \cdot T_0 / q$. For $p=5$, $U_{OR-} = 650$ mV, the relation is $R_T/R_E = 31$.

Let us reduce U_{T+} voltage to the reference temperature of T_0

$$U_{T+} = \frac{R_T}{R_E} \frac{mk(T_0 + T - T_0) \ln p}{2q} = \quad (21)$$

$$\frac{R_T}{R_E} \left(\frac{mkT_0 \ln p}{2q} + \frac{mk(T - T_0) \ln p}{2q} \right);$$

$$U_{T+} = \frac{R_T}{R_E} \frac{m\varphi_{T0} \ln p}{2} \left(1 + \frac{T - T_0}{T_0} \right) \quad (22)$$

By substitution of relation R_T/R_E , for $U_{OR-} = U_{OR+}$

$$\frac{R_T}{R_E} = \frac{2U_{OR-}}{m\varphi_{T0} \ln p}, \quad (23)$$

the following equation can be obtained

$$U_{T+} = U_{OR-} \left(1 + \frac{T - T_0}{T_0} \right) = U_{OR-} \frac{T}{T_0} \quad (24)$$

It allows to determine TFV (U_{T+})

$$\frac{dU_{T+}}{dT} = \frac{U_{OR-}}{T_0} \quad (25)$$

For the reference temperature $T_0 = 300$ K, the TFV(U_{T+}) is with $U_{T-}(300 \text{ K}) = 600$ mV, $dU_{T+}/dT = 2.00$ mV/K, with $U_{T-}(300 \text{ K}) = 650$ mV, $dU_{T+}/dT = 2.17$ mV/K, for $U_{T-}(300 \text{ K}) = 700$ mV, $dU_{T+}/dT = 2.33$ mV/K.

2.1 Simulation and experimental results

The examples of temperature dependencies of transducer output voltage $U_{OUT} = U_{T+} - U_{T-}$ for various values of reference temperatures and transconductance of transduction are given in Figure 2. The results of probe indicate that non-linearity of temperature characteristics of output voltage is less than 1% in the range of $-25 \dots +75^\circ\text{C}$. The supply voltage of IC was over 3 V and the consumption current is up to 3 mA.

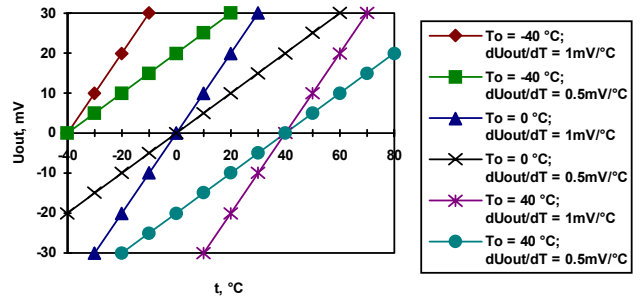


Fig. 2 The examples of temperature characteristics of transducer with relative temperature reading achieved by simulation.

It can be shown that by regulation of direct voltage on diode, for example by choosing area of diode, p factor of nominal of current-set resistor, the regime at which the conditions of $U_{OR+} = U_{OR-}$ and $dU_{T+}/dT = -dU_{T-}/dT$ are fulfilled can be realised. It takes place at

$$\frac{E_{GO} - U_{OR-}}{T_0} + 0,17 = \frac{U_{OR-}}{T_0}, \quad (26)$$

i.e. at

$$U_{OR-} = \frac{E_{GO} (mV) + 0,17T_0}{2}. \quad (27)$$

The conditions are fulfilled for $T = 0^\circ\text{C}$ at $U_{OR-} = 626$ mV, for $T = 27^\circ\text{C}$ (nominal temperature of "P-SPICE" modelling) at $U_{OR-} = 628$ mV, and for $T = 35^\circ\text{C}$ (reference temperature for medical thermometer) at $U_{OR-} = 629$ mV.

The reference temperature dependent on voltage U_0 is assigned by R_L potentiometer as

$$U_0 = U_{T-} + (U_{T+} - U_{T-}) \cdot (1-L), \quad (28)$$

where $L \in (0, 1)$ is the relative position from the midpoint of potentiometer. When TFV of U_{T-} , U_{T+} are equal, the reference voltage does not depend on temperature in the point of $L = 0.5$ and the value of reference voltage is $U_0 = U_{OR-} = U_{OR+}$

3. Conclusions

The principle and the detailed electrical scheme of the transducer unit of thermosensitive IC with relative temperature reading are proposed. The algorithm functioning is in formatting of current with linear dependence on the absolute temperature by the further transduction of the current into differential signal the value of which is determined by relative temperature scale. In contrast to analogues, the temperature controlled voltage and reference voltage of proposed IC are formed in the single unit. The transducer is characterised by high linearity of transduction function, reproducibility of characteristics, minimum non-

stability at the variation of supply voltage and simplicity of realisation scheme.

References

- [1] Smart temperature sensors, *Electronics & Wireless world*. vol. 95, no. 1636, 1989, p.189-190.
- [2] GOTRA Z., GOYAKA R., KALITA W., NEVMERGHYTSKA A. Energy independent micro-electronic thermometer based on liquid crystal indicator, *Proceedings of 18th Conf. of ISHM Poland*. Warsaw, Sept. 1994, p.129-132.
- [3] GOTRA O., STADNYK B., GOLYAKA R., POTENCKI J.: Thermosensitive IC for relative temperature determination, *Proceeding of the 22-nd Conference of IMAPS Poland*, Zakopane, Oct. 1998, Krakow 1999, p.175-178.
- [4] SIDNEY F.: *Analog Integrated Circuits*: Prentice-Hall, Inc., Englewood Cliffs, NJ 0732, 1985, p.583.

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